

ECEE 2022

European Conference on Electronic Engineering

June 8 - 11, 2022 | Berlin, Germany

 <http://ecee.org/>

ECEE 2022 is an international forum for reporting technological breakthroughs in the areas of electronic technology, design, manufacturing, physics, and modeling. An important goal of ECEE is to provide an environment that encourages interplay between scientific and technological issues. Invited and contributed talks, are presented in an informal setting designed to encourage discussion, and conference participants enjoy numerous opportunities for social gatherings with renown scientists and engineers. Papers describing original work are invited in any of the electronics engineering areas that the call for papers considers.

Conference Proceedings

Accepted papers will be included into conference proceedings, which have been indexed in the past by **Scopus**, **Ei Compendex**, etc.

Conference Venue (Pending)



Sheraton Berlin Grand Hotel Esplanade
Add: Lützowufer 1510785, Berlin, Germany
Web: <https://www.esplanade.de/en/>

Submission

Due January 15, 2022

Online Submission System:

<https://www.zmeeting.org/submission/ecee2022>

E-mail Submission: ecee@academic.net

Call for Papers

Topics of interest include, but are not limited to:

Electronic Science and Technology
Electronic Information Engineering and Application
Analogue electronic engineering
Radio frequency electronic engineering
Digital development engineering
Programmable logic engineering
Component engineering
Electromagnetic compatibility
Electrotechnologies
Electromagnetics
Instrumentation engineering
Circuits and systems
VLSI design engineering
Semiconductor and devices
Physical electronics
Microelectronics and solid state electronics

Electromagnetic field and microwave technology
Microwave technology and antenna
Microwave circuit technology
Integrated circuit design and manufacturing
Measuring technology and instruments
Electric vehicle technologies
Materials for electrotechnics
Power quality and electromagnetic compatibility
Power electronics, systems and applications
Electrical machines and adjustable speed drives
Signal and information processing
Systems engineering
Reliability engineering
Digital/Logic Electronic Engineering
DSP system
Programmable logic device
Hardware design
Embedded system and intelligent control
Modern sensing and measurement technology
Wireless circuits and systems
High voltage engineering and insulation technology
Electrical machinery and electrical apparatus

Contact us

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